

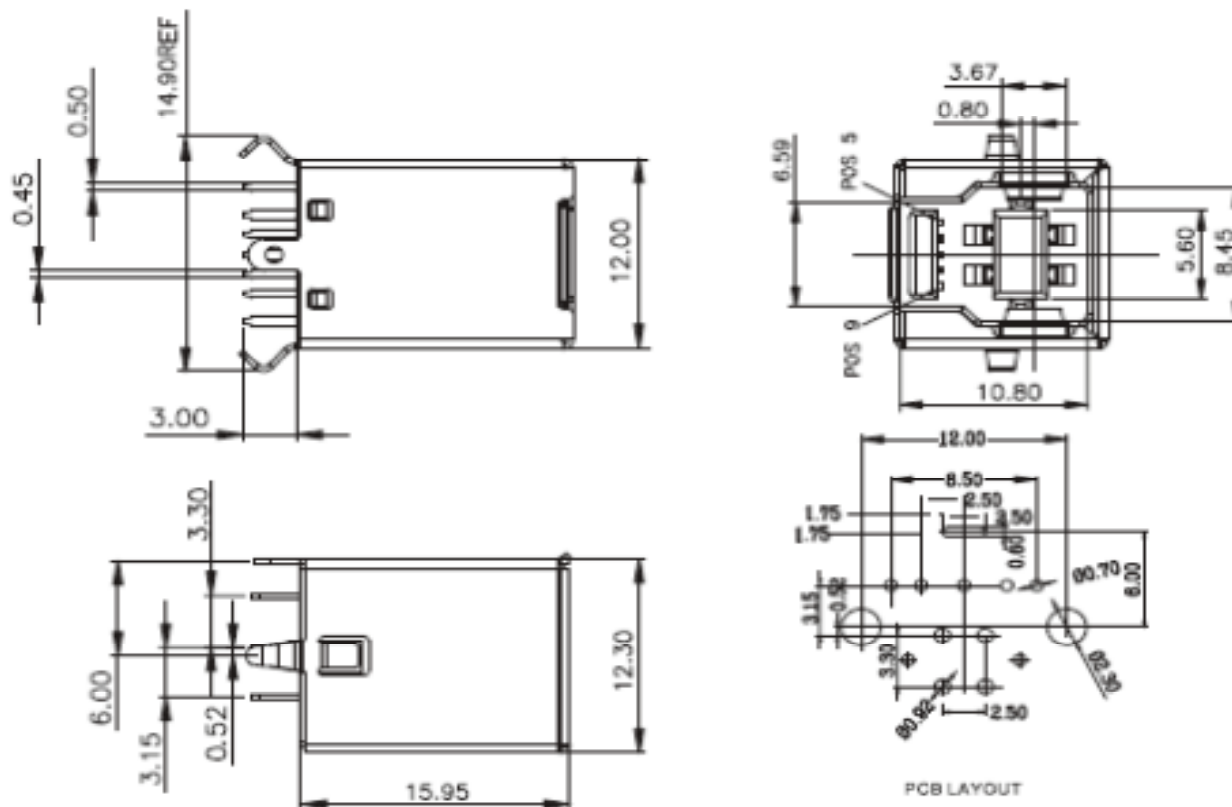
# EDCON-COMPONENTS



## Specifications

Voltage Rating:	
Current Rating:	Pin 1+4 1,8A other 0,25A
Operating Temperature:	
Contact Resistance:	Pin 1+4 30mOhm other 50mOhm
Withstanding Voltage:	100V AC
Insulation Resistance:	100 Megaohm Min.
Mating Force:	35 Newtons max.
Unmating Force:	10 Newtons max.
Material Housing:	LCP, Nylon or PBT Blue/Black
Contact:	Copper Alloy
Shell:	copper alloy, SUS or SPCC
Contact Plating:	Au plated on contact area Tin plated on solder area Nickel underplating overall Nickel plating
Shell:	
<b>Connecting Cycle by</b>	
Gold Flash plating	min.3000 times

## Drawing ( dimensions all into mm)



## USB-3.0 Connector

Part No.: **T65061-**

Customer:

DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	26.01.2018
APPD:	Schumi			FINISH	Jamy		Sheet No.	1 from 3	

# EDCON-COMPONENTS



## Ordering Informations

Serie	Contact plating	Body color	Shell Plating	special function	ROHS	Packing				
<b>T65061-</b>	<b>1</b>	<b>BL</b>	<b>1</b>	<b>XX</b>	<b>R</b>	<b>BU</b>				

1= Gold Flash/Tin	<b>BL=</b> Blue	1= Nickel plated	<b>xx=</b> No special order	R= ROHS conform	<b>BU=</b> Bulk-Ware
1= Gold 2-3µ Tin	<b>BK=</b> Black	2= AU plated		N= Non ROHS	<b>TY=</b> Tray Packing
1= Gold Flash overall	<b>WH=</b> White				<b>IV=</b> Individual Packing
	<b>BG=</b> Beige				

### USB-3.0 Connector

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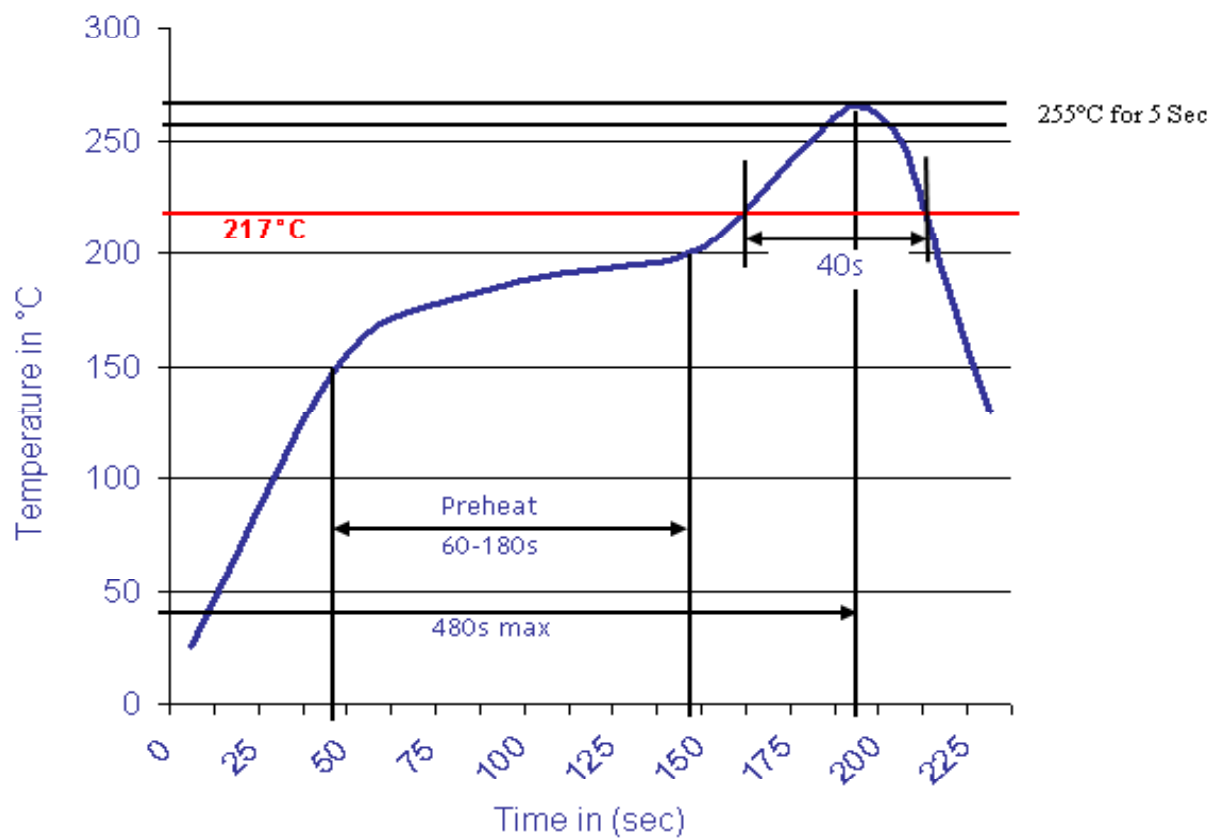
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Soldering Profile Curve

Classification Reflow Profile (JEDEC J-STD-020C)



**USB-3.0 Connector**

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